

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**POWER OF ATTORNEY BY ASSIGNEE WITH STATEMENT UNDER 37 C.F.R. 3.73(b)**  
**AND REVOCATION OF PREVIOUS POWERS**

Sir:

As the assignee of record of the entire right, title and interest of the below-identified patent applications by virtue of assignment from inventor(s) to assignee, all powers of attorney previously given are hereby revoked and the attorneys associated with:

**Customer No.: 30256**

are hereby appointed to prosecute and transact all business in the U.S. Patent and Trademark Office connected therewith.

**Patent Applications**

U.S. PATENT APPLICATION NO.	FILING DATE	TITLE	INVENTOR(S)	ASSIGNMENT RECORDED FROM INVENTOR(S) TO ASSIGNEE UNITED MICROELECTRONICS, INC. AT REEL/FAME
10/954,735	9/30/2004	Cmos Silicon-Control-Rectifier (Scr) Structure For Electrostatic Discharge (Esd) Protection	Shiao-Shien CHEN et al.	018157/0319
09/624,321	7/24/2000	Method And Structure For Reducing Capacitance Between Interconnect Lines	Bing-Chang WU	010961/0923
09/847,111	5/2/2001	Measuring System Of A Gas Stream Environment	Ya-Chuan CHENG	011779/0598
10/105,339	3/26/2002	Method Of Reducing The Chamber Particle Level	Yen-Wu HSIEH	012731/0632
10/986,840	11/15/2004	Method And Structure To Improve The Gate Coupling Ratio (Gcr) For Manufacturing A Flash Memory Device	Wen-Fang LEE et al.	014502/0557
10/837,638	5/4/2004	Mask Device For Photolithography And Application Thereof	Benjamin Szu-Min LIN	015299/0453


10/843,444	5/12/2004	Method Of Cleaning A Semiconductor Substrate And Cleaning Recipes	Ya-Lun CHENG et al.	015322/0921
10/784,186	2/24/2004	Method For Gap Filling Between Metal-Metal Lines	LIN, PING-WEI et al.	015024/0770

I am empowered to act on behalf of the corporation identified below.

Respectfully submitted,

United Microelectronics, Inc.

Date: 2006/10/18

  
 By: Joey Lai  
 Manager of IP Department  
 United Microelectronics, Inc.